

**MOTOROLA SC XSTRS/R F**  
**SEMICONDUCTOR**  
**TECHNICAL DATA**

**The RF Line****NPN SILICON MICROWAVE POWER TRANSISTOR**

... designed for Class B and C *common base* broadband amplifier applications in the 1.7 to 2.3 GHz frequency range.

- Internal Input Matching for Broadband Operation
- Guaranteed Performance @ 2 GHz, 24 Vdc  
Output power = 5.0 Watts  
Minimum Gain = 7.5 dB
- 100% Tested for Load Mismatch at All Phase Angles with 10:1 VSWR
- Hermetically Sealed Industry Standard Package
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- Silicon Nitride Passivation
- Characterized for Operation from 20 V to 28 V Supply Voltages

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	20	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	45	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	3.5	Vdc
Collector-Current — Continuous	I <sub>C</sub>	1.0	Adc
Total Device Dissipation @ T <sub>C</sub> = 25°C (1)	P <sub>D</sub>	22	Watts
Derate above 25°C		130	mW/°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +200	°C

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (2)	R <sub>θJC</sub>	8.0	°C/W

(1) This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.

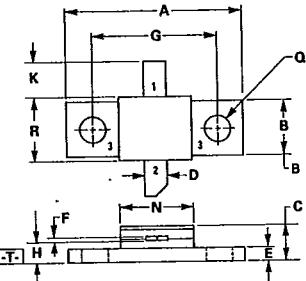
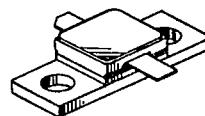
(2) Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques.

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5.0 W 2 GHz

**MICROWAVE POWER TRANSISTOR**

NPN SILICON



## NOTES:

1. DIMENSIONS [A] AND [B] ARE DATUMS
2. POSITIONAL TOLERANCE FOR MOUNTING HOLES:  
+0.13 (-0.05) @ T A @ B @
3. [T] IS SEATING PLANE.
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	20.07	20.57	0.790	0.810
B	6.48	6.73	0.255	0.265
C	3.68	4.06	0.145	0.160
D	2.29	2.79	0.090	0.110
E	1.42	1.73	0.056	0.068
F	0.05	0.15	0.002	0.006
G	14.27 BSC		0.560 BSC	
H	2.29	2.79	0.090	0.110
K	3.43	4.19	0.135	0.165
N	7.87	8.38	0.310	0.330
O	3.05	3.30	0.120	0.130
R	7.24	7.49	0.285	0.295

CASE 337-02

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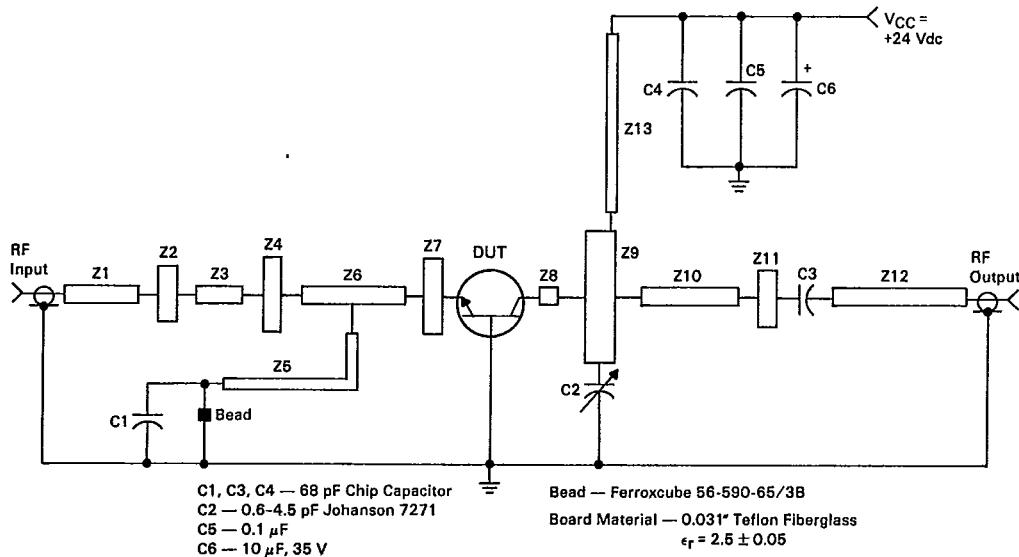
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ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector-Emitter Breakdown Voltage ( $I_C = 10 \text{ mA}_\text{dc}$ , $I_B = 0$ )	$V_{(\text{BR})\text{CEO}}$	20	—	—	Vdc
Collector-Emitter Breakdown Voltage ( $I_C = 10 \text{ mA}_\text{dc}$ , $V_{BE} = 0$ )	$V_{(\text{BR})\text{CES}}$	45	—	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 10 \text{ mA}_\text{dc}$ , $I_E = 0$ )	$V_{(\text{BR})\text{CBO}}$	45	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 2.0 \text{ mA}_\text{dc}$ , $I_C = 0$ )	$V_{(\text{BR})\text{EBO}}$	3.5	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 28 \text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	—	—	1.0	$\text{mA}_\text{dc}$
<b>ON CHARACTERISTICS</b>					
DC Current Gain ( $I_C = 300 \text{ mA}_\text{dc}$ , $V_{CE} = 5.0 \text{ Vdc}$ )	$h_{FE}$	10	—	100	—
<b>DYNAMIC CHARACTERISTICS</b>					
Output Capacitance ( $V_{CB} = 24 \text{ Vdc}$ , $I_E = 0$ , $f = 1.0 \text{ MHz}$ )	$C_{ob}$	—	7.5	10	pF
<b>FUNCTIONAL TESTS</b>					
Common-Base Amplifier Power Gain ( $V_{CC} = 24 \text{ Vdc}$ , $P_{out} = 5.0 \text{ W}$ , $f = 2.0 \text{ GHz}$ )	$G_{PB}$	7.5	8.0	—	dB
Collector Efficiency ( $V_{CC} = 24 \text{ Vdc}$ , $P_{out} = 5.0 \text{ W}$ , $f = 2.0 \text{ GHz}$ )	$\eta$	35	40	—	%
Load Mismatch ( $V_{CC} = 24 \text{ Vdc}$ , $P_{out} = 5.0 \text{ W}$ , $f = 2.0 \text{ GHz}$ ) VSWR = 10:1 All Phase Angles	$\psi$	No Degradation in Power Output			

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FIGURE 1 — 2.0 GHz TEST CIRCUIT



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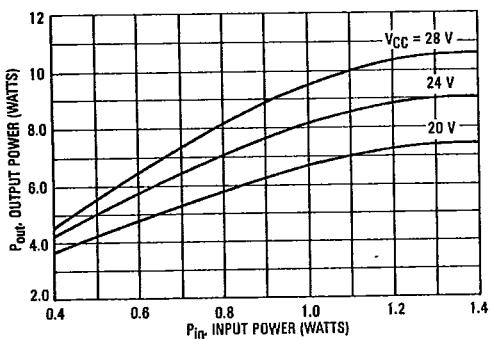
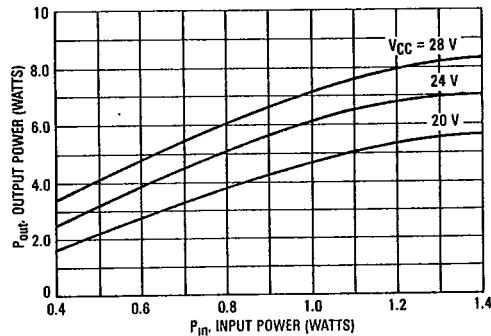
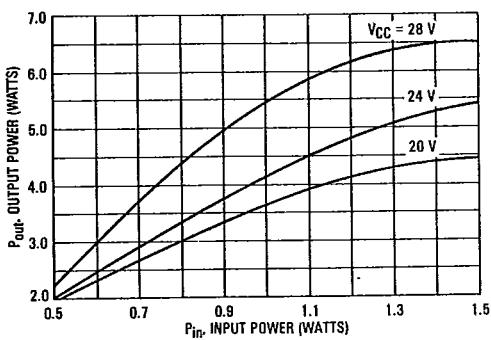
FIGURE 2 — OUTPUT POWER versus INPUT POWER  
(f = 1.7 GHz)FIGURE 3 — OUTPUT POWER versus INPUT POWER  
(f = 2.0 GHz)FIGURE 4 — OUTPUT POWER versus INPUT POWER  
(f = 2.3 GHz)

FIGURE 5 — POWER GAIN versus FREQUENCY

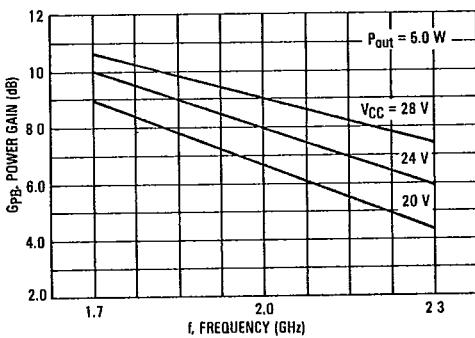
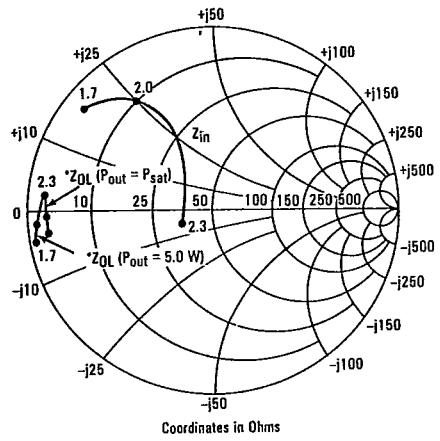


FIGURE 6 — SERIES EQUIVALENT INPUT/OUTPUT IMPEDANCE

 $V_{CC} = 24\text{ V}$ 

$f$ GHz	$Z_{in}$ Ohms	$Z_{out}^*$ : Ohms $P_{out} = P_{sat}$	$Z_{out}^*$ : Ohms $P_{out} = 5.0\text{ W}$
1.7	$4.0 + j17$	$2.9 - j3.5$	$1.5 - j4.4$
2.0	$10 + j25$	$3.1 - j0.85$	$1.75 - j1.3$
2.3	$37 - j5.0$	$2.9 + j2.2$	$2.90 + j2.2$

\* $Z_{out}$  = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage, and frequency.

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FIGURE 7 — 2 GHz TEST AMPLIFIER

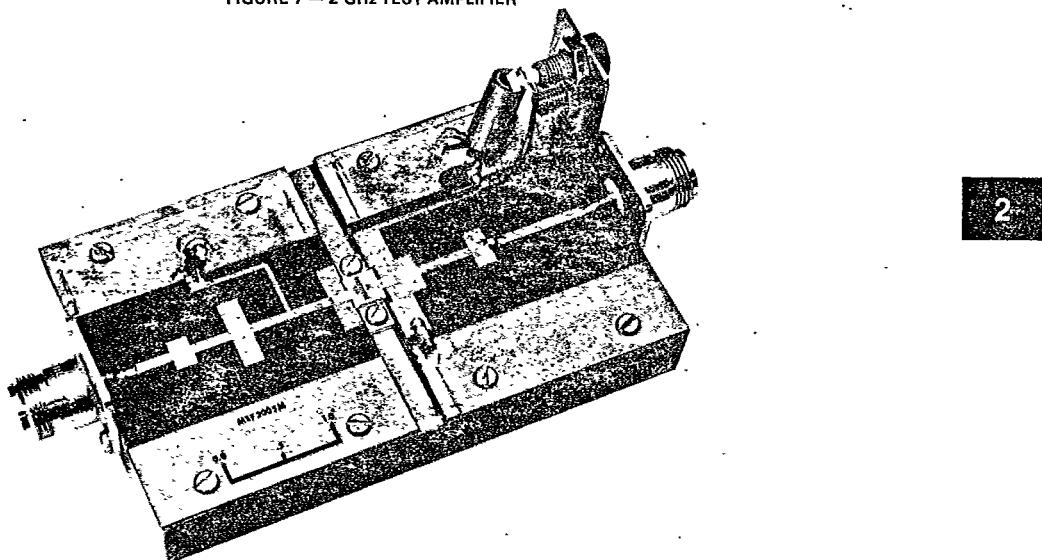
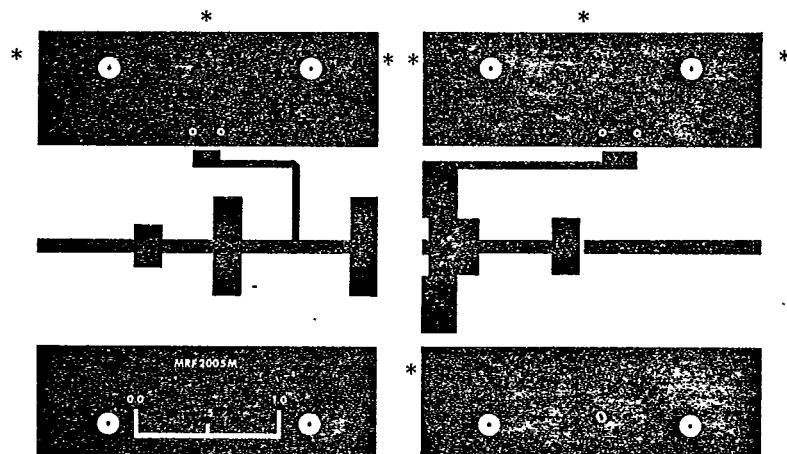


FIGURE 8 — PRINTED CIRCUIT BOARD LAYOUT — 2.0 GHz TEST CIRCUIT



- Denotes Eyelet
- 4-40 Screw Placement
- \* Foil Wrap to Bottom
- Ground Plane

NOTE: The Printed Circuit Board shown is 75% of the original.

MOTOROLA RF DEVICE DATA

2-1015